DATA SHEET



NPN SILICON GERMANIUM RF TRANSISTOR

NESG2046M33

NPN SiGe RF TRANSISTOR FOR LOW NOISE, HIGH-GAIN AMPLIFICATION 3-PIN SUPER LEAD-LESS MINIMOLD (M33, 0804 PKG)

FEATURES

- The device is an ideal choice for low noise, high-gain amplification NF = 0.8 dB TYP., $G_a = 11.5$ dB TYP. @ $V_{CE} = 1$ V, $I_C = 3$ mA, f = 2 GHz
- High breakdown voltage technology for SiGe Tr. adopted: VcEo (absolute maximum ratings) = 5.0 V
- 3-pin super lead-less minimold (M33, 0804 PKG) package

ORDERING INFORMATION <R>

Part Number	Order Number	Package	Quantity	Supplying Form
NESG2046M33	NESG2046M33-A	3-pin super lead-less	50 pcs (Non reel)	• 8 mm wide embossed taping
NESG2046M33-T3	NESG2046M33-T3-A	minimold (M33, 0804 PKG) (Pb-Free)	10 kpcs/reel	Pin 2 (Base) face the perforation side of the tape

Remark To order evaluation samples, contact your nearby sales office. Unit sample quantity is 50 pcs.

ABSOLUTE MAXIMUM RATINGS ($T_A = +25$ °C)

Parameter	Symbol	Ratings	Unit
Collector to Base Voltage	Vcво	13	V
Collector to Emitter Voltage	Vceo	5	V
Emitter to Base Voltage	V _{EBO}	1.5	V
Collector Current	lc	40	mA
Total Power Dissipation	Ptot Note	130	mW
Junction Temperature	Tj	150	°C
Storage Temperature	T _{stg}	-65 to +150	°C

Note Mounted on 1.08 cm² × 1.0 mm (t) glass epoxy PCB

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

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Not all products and/or types are available in every country. Please check with an NEC Electronics sales representative for availability and additional information.

ELECTRICAL CHARACTERISTICS (TA = +25°C)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
DC Characteristics						
Collector Cut-off Current	Ісво	VcB = 5 V, IE = 0 mA	-	-	100	nA
Emitter Cut-off Current	Іво	VEB = 0.5 V, Ic = 0 mA	-	-	100	nA
DC Current Gain	hfE Note 1	VcE = 1 V, Ic = 2 mA	140	180	220	-
RF Characteristics						
Gain Bandwidth Product	f⊤	VcE = 1 V, Ic = 15 mA, f = 2 GHz	15	18	-	GHz
Insertion Power Gain	S _{21e} ²	VcE = 1 V, Ic = 15 mA, f = 2 GHz	11	13	-	dB
Noise Figure	NF	$V_{CE} = 1 \text{ V}, \text{ Ic} = 3 \text{ mA}, \text{ f} = 2 \text{ GHz},$ $Z_{S} = Z_{Sopt}, Z_{L} = Z_{Lopt}$	-	0.8	1.5	dB
Associated Gain	Ga	$\begin{aligned} &V_{\text{CE}} = 1 \text{ V, Ic} = 3 \text{ mA, f} = 2 \text{ GHz,} \\ &Z_{\text{S}} = Z_{\text{Sopt}}, \ Z_{\text{L}} = Z_{\text{Lopt}} \end{aligned}$	9.5	11.5	-	dB
Reverse Transfer Capacitance	Cre Note 2	VcB = 1 V, IE = 0 mA, f = 1 MHz	=	0.2	0.4	pF

Notes 1. Pulse measurement: PW \leq 350 μ s, Duty Cycle \leq 2%

2. Collector to base capacitance when the emitter grounded

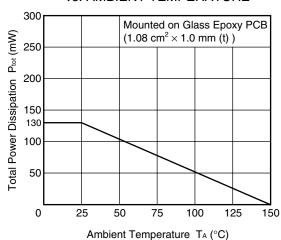
hfe CLASSIFICATION

Rank	FB		
Marking	T7		
h _{FE} Value	140 to 220		

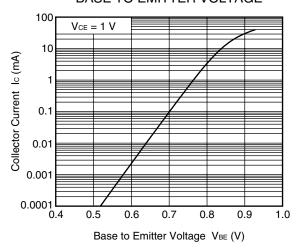
2

<R> TYPICAL CHARACTERISTICS (TA = +25°C, unless otherwise specified)

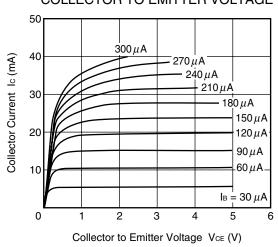
TOTAL POWER DISSIPATION vs. AMBIENT TEMPERATURE



COLLECTOR CURRENT vs. BASE TO EMITTER VOLTAGE

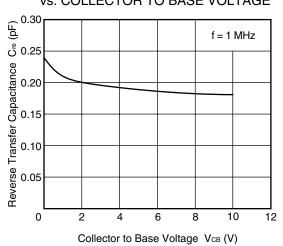


COLLECTOR CURRENT vs. COLLECTOR TO EMITTER VOLTAGE

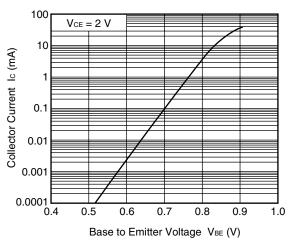


Remark The graphs indicate nominal characteristics.

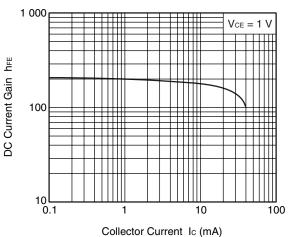
REVERSE TRANSFER CAPACITANCE vs. COLLECTOR TO BASE VOLTAGE



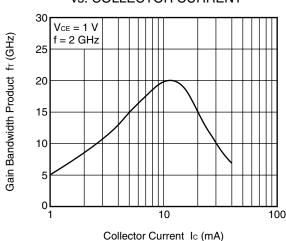
COLLECTOR CURRENT vs. BASE TO EMITTER VOLTAGE



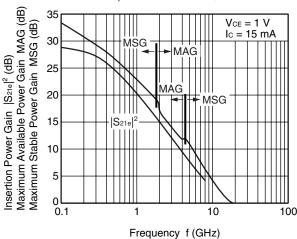
DC CURRENT GAIN vs. **COLLECTOR CURRENT**



GAIN BANDWIDTH PRODUCT vs. COLLECTOR CURRENT

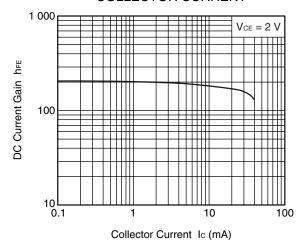


INSERTION POWER GAIN, MAG, MSG vs. FREQUENCY

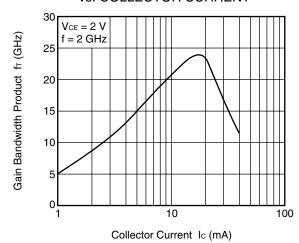


Remark The graphs indicate nominal characteristics.

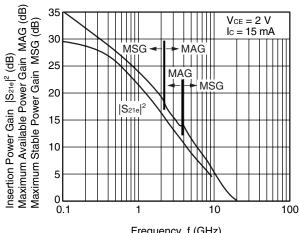
DC CURRENT GAIN vs. **COLLECTOR CURRENT**



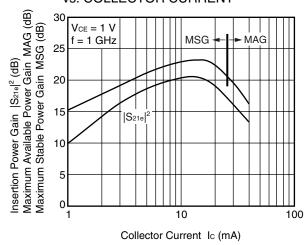
GAIN BANDWIDTH PRODUCT vs. COLLECTOR CURRENT



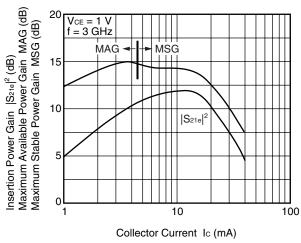
INSERTION POWER GAIN. MAG, MSG vs. FREQUENCY



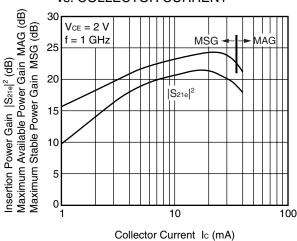
INSERTION POWER GAIN, MAG, MSG vs. COLLECTOR CURRENT



INSERTION POWER GAIN, MAG, MSG vs. COLLECTOR CURRENT

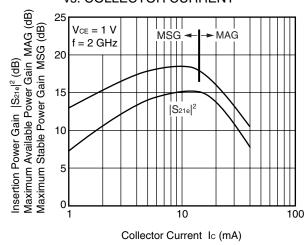


INSERTION POWER GAIN, MAG, MSG vs. COLLECTOR CURRENT

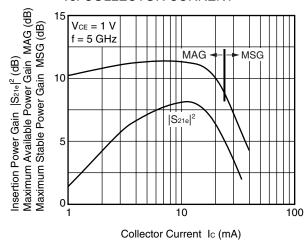


Remark The graphs indicate nominal characteristics.

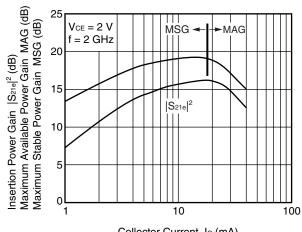
INSERTION POWER GAIN, MAG, MSG vs. COLLECTOR CURRENT



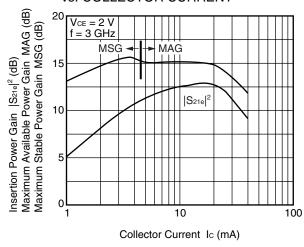
INSERTION POWER GAIN, MAG, MSG vs. COLLECTOR CURRENT



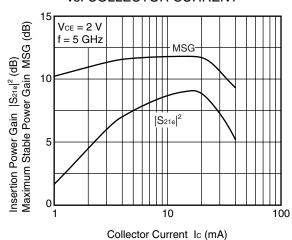
INSERTION POWER GAIN, MAG, MSG vs. COLLECTOR CURRENT



INSERTION POWER GAIN, MAG, MSG vs. COLLECTOR CURRENT



INSERTION POWER GAIN, MSG vs. COLLECTOR CURRENT



Remark The graphs indicate nominal characteristics.

<R> S-PARAMETERS

S-parameters and noise parameters are provided on our Web site in a format (S2P) that enables the direct import of the parameters to microwave circuit simulators without the need for keyboard inputs.

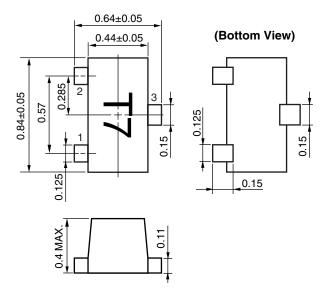
Click here to download S-parameters.

[RF and Microwave] \rightarrow [Device Parameters]

URL http://www.necel.com/microwave/en/

PACKAGE DIMENSIONS

3-PIN SUPER LEAD-LESS MINIMOLD (M33, 0804 PKG) (UNIT: mm)



PIN CONNECTIONS

- 1. Emitter
- 2. Base
- 3. Collector

7

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